



PRODUCT DATASHEET



- Ceramic High Power
- ▶ 3535 3.8t Series
- ► Warm White 3000K



3535 3.8t Series



FEATURES:

- Package: Ceramic SMT Package with Silicone Lens
- Forward Current: 350~700mA
- Forward Voltage (typ.): 3.2V
- Luminous Flux (typ.): 100lm@350mA
- Colour: Warm White
- Colour Temperature (CCT): 3000K
- Viewing angle: 130°
 - Materials:
 - Die: InGaN
 - Resin: Silicon (Water Clear)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- Grouping parameters:
 - Forward Voltage
 - Luminous Flux
 - CIE Chromaticity
- Soldering methods: IR Reflow Soldering
- **Preconditioning:** MSL 4 according to J-STD020
- Packing: 12mm tape with max.1000pcs/reel, ø180mm (7")

N0W62S50



APPLICATIONS:

- Portable Lighting
- Outdoor Lighting
- Commercial Lighting
- Indoor Lighting

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- Industrial Lighting
- Street and Tunnel Lighting



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	lf	700	mA
Pulse Forward Current, D=0.01s Duty 1/10	Ipf	1000	mA
Reverse Current @5V	IR	10	μΑ
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	125	°C
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Т _{stg}	-40~+100	°C
Soldering Temperature	Tsol	260	°C
Thermal Resistance - Junction to Solder Point	Rth	12	°C/W

Electrical & Optical Characteristics (Ta=25°C)

Devenenter	Currente e l	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Typ. Max.		Condition	
Forward Voltage	VF	2.8	3.2	3.6	V	I⊧=350mA	
Luminous Flux	Φv	90		110	lm	I⊧=350mA	
Chromaticity	х		0.4342			L = 250m A	
Coordinates	Y		0.4028			I⊧=350mA	
Colour Temperature	ССТ	2860	3000	3220	К	I⊧=350mA	
Colour Rendering Index	CRI	90	95			I⊧=350mA	
Viewing Angle	20 _{1/2}		130		deg	I⊧=350mA	

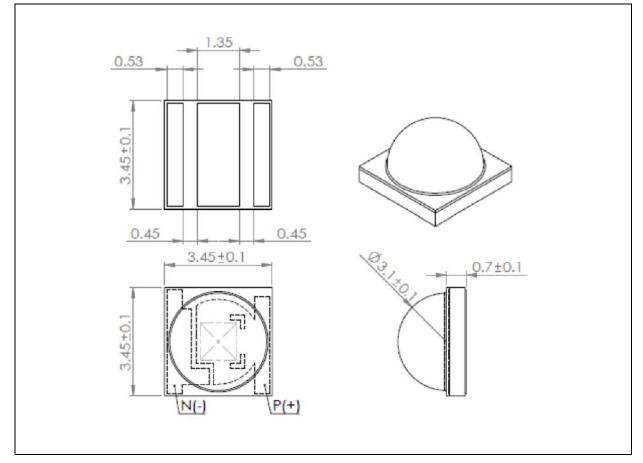
1. Luminous flux (Φ_V) ±7%, Forward Voltage (V_F) ±0.05V, Viewing angle(2 $\theta_{1/2}$) ±10°

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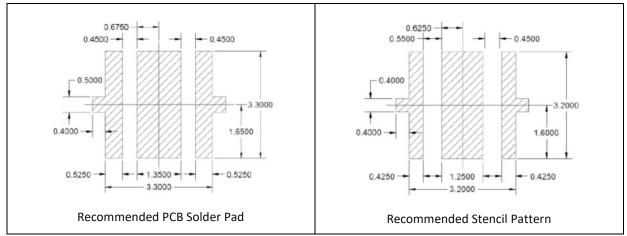


OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.



Recommended Soldering Pad Dimension:

- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.12 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 350mA):

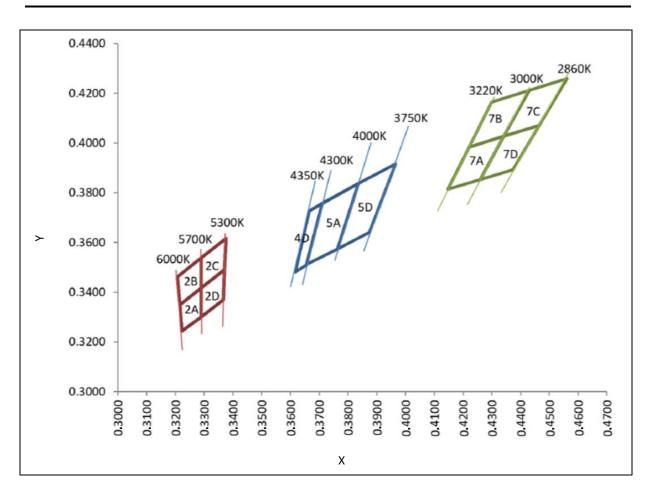
Code	Min.	Max.	Unit
V1	2.8	3.0	
V2	3.0	3.2	M
V3	3.2	3.4	v
V4	3.4	3.6	

Luminous Flux Classifications (I_F = 350mA):

Code	Min.	Max.	Unit
L09	90	100	lue
L10	100	110	Im



CIE CHROMATICITY DIAGRAM:

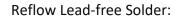


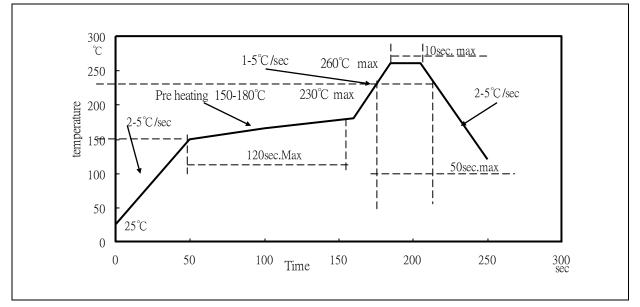
Chromaticity Coordinates Classifications (I_F = 350mA):

	1	L	2		3		4	
	х	Y	х	Y	Х	Υ	х	Υ
7A	0.4147	0.3814	0.4221	0.3984	0.4342	0.4028	0.4259	0.3853
7B	0.4221	0.3984	0.4299	0.4165	0.4430	0.4212	0.4342	0.4028
7C	0.4342	0.4028	0.4430	0.4212	0.4562	0.4260	0.4465	0.4071
7D	0.4259	0.3853	0.4342	0.4028	0.4465	0.4071	0.4373	0.3893



RECOMMENDED SOLDERING PROFILE:





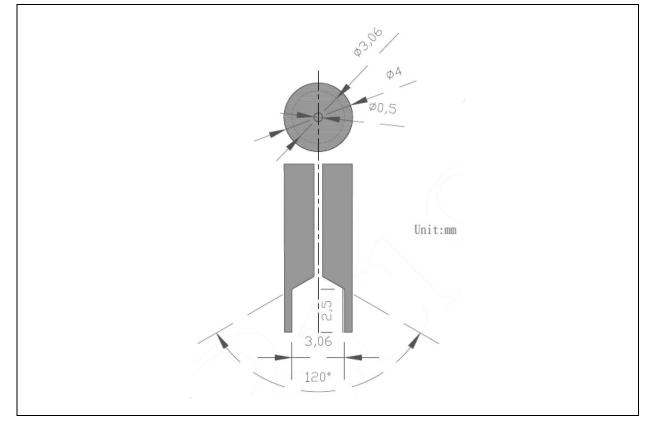
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. The recommended reflow temperature is 240°C. The maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



RECOMMENDED NOZZLE FOR SMT:

Recommended Pick & Place Nozzle:



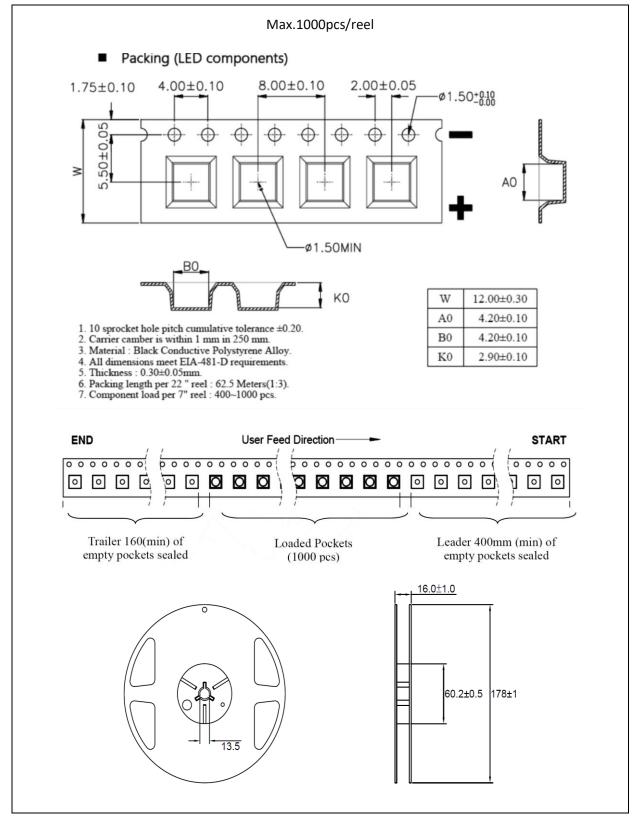
- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.
- 3. Do not apply more than 4N onto the lens.

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PACKING SPECIFICATION:

Reel Dimension:



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PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 15hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	29/09/2022	Datasheet set-up.